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LH1527, LH1537 1 Form C

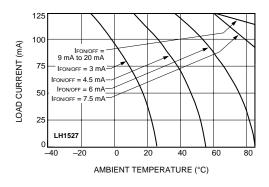
Absolute Maximum Ratings T_A=25°C

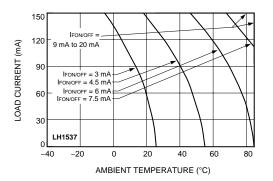
Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to Absolute Maximum Ratings for extended periods of time can adversely affect reliability.

Parameter	Symbol	Test Conditions	LH1527	LH1537	Units
Ambient Operating Temperature Range	T _A	_	-40 to +85	-40 to +85	°C
Storage Temperature Range	T _{stg}	—	-40 to +150	-40 to +150	°C
Pin Soldering Temperature	T _S	t=10 s max	260	260	°C
Input/Output Isolation Voltage	V _{ISO}	—	3750	3750	Vrms
Pole-to-Pole Isolation Voltage* (S1 to S2)	_	Dry air, dust free, at sea level	1600	1600	V
LED Continuous Forward Current	I _F	—	50	50	mA
LED Reverse Voltage	V _R	I _R ≤ 10 μA	8	8	V
dc or Peak ac Load Voltage	VL	I _L ≤ 50 μA	350	250	V
Continuous dc Load Current (Form C Operation)	IL.	_	125	150	mA
Peak Load Current	I _P	t=100 ms (single shot)	350	500	mA
Output Power Dissipation (continuous) 6-Pin Package 8-Pin Package	P _{DISS}	_	500 600	500 600	mW mW

* Breakdown occurs between the output pins external to the package.

Recommended Operating Conditions





Electrical Characteristics $T_A=25^{\circ}C$ Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the

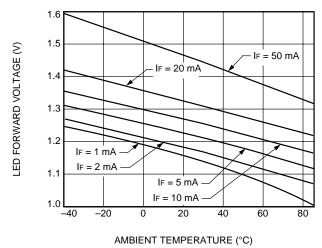
result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

	Parameter	Symbol	Test Condition	Values	LH1527	LH1537	Units
	LED Forward Current	I _{Fon}	I _I =100 mA	Min	-	-	mA
	for Switch Turn-on		t=10 ms	Тур	2.0	2.0	mA
	(NO)			Max	3.0	3.0	mA
	LED Forward Current	I _{Foff}		Min	0.2	0.2	mA
	for Switch Turn-off	1 OII		Тур	1.0	1.0	mA
	(NO)			Max	300	200	mA V
Т				±			
N P	LED Forward Current	IFon	I _L =100 mA	Min	0.2	0.2	mA
PU	for Switch Turn-on		t=10 ms	Тур	0.6	0.6	mA
Т	(NC)			Max	-	-	mA
	LED Forward Current	I _{Foff}	—	Min Typ	0.7	0.7	mA mA
	for Switch Turn-off			Max	3.0	3.0	mA
	(NC)		VL	±	300	200	V
	LED Forward	V _F	I _F =10 mA	Min	1.15	1.15	V
	Voltage	· F	IF IOIN#C	Тур	1.26	1.26	V
	Voltago			Max	1.45	1.45	V
	ON-resistance:	Bass	I _F =5 mA (NO),	Min	17*	8	Ω
	(NO, NC)	R _{ON}	0 mA (NC)	Тур	25*	12	Ω
			. ,	Max	33*	16	Ω
			I _L =50 mA (NC)	Min	0.5	0.5	GΩ
	OFF-resistance	R _{OFF}	I _F =0 mA				
	(NO)		$V_{L}=\pm 100 V$	Тур	600	600	GΩ
				Max	-	-	GΩ
	(NC)		I _F =5 mA	Min	0.1	0.1	GΩ
			$V_L=\pm 100 V$	Тур	5.0	5.0	GΩ
				Max	—	—	GΩ
	Off-state	—	I _F =0 mA	Min	-	—	nA
	Leakage Current		$V_L=\pm 100 V$	Тур	0.17	0.17	nA
	(NO)			Max	200	200	nA
	(NC)		I _F =5 mA	Min	-	-	μΑ
•			$V_L=\pm 100 V$	Тур	0.02	0.02	μΑ
O U				Max	1.0	1.0	μΑ
T P	(NO, NC)		I _F =0 mA (NO)	Min		-	μΑ
U			$I_{\rm F}=5$ mA (NC)	Тур	_	_	μΑ
т				Мах	1.0	1.0	μΑ
			VI	±	350	250	V
	Output Capacitance		I _F =0 mA	Min			pF
	(NO)		$V_{I} = 1 V$	Тур	55	60	pF
				Max			pF
			I _F =0 mA	Min	<u> </u>		pF
			$V_{I} = 50 V$	Тур	10	15	pF
				Max		_	pF
	(NC)		$I_{F}=5 \text{ mA}$	Min	-		pF
			V _L =1 V	Тур	35	45	pF
				Max	-	-	pF
			I _F =5 mA	Min	—	—	pF
			$V_L=50 V$	Тур	10	15	pF
				Max	-	-	pF

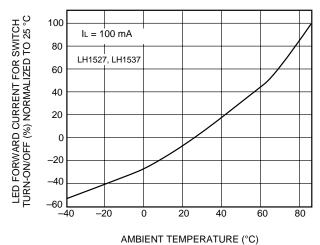
	Parameter	Symbol	Test Condition	Values	LH1527	LH1537	Units
	Pole-to-pole Capacitance	_	I _F =0 mA	Min	-	_	pF
	(S1 to S2)			Тур	0.5	0.5	pF
0				Max	-	-	pF
U T	Switch Offset	_	I _F =5 mA (NO)	Min	-	-	μV
Р	(NO)		I _F =5 mA (NC)	Тур	0.15	0.15	μV
U T				Max	-	-	μV
	Switch Offset		I _F =0 mA (NC)	Min	-	-	μV
	(NC)		I _F =5 mA (NO)	Тур	0.1	0.1	μV
				Max	-	-	μV
	Input/Output	C _{ISO}	V _{ISO} =1 V	Min		—	pF
	Capacitance	100		Тур	1.1	1.1	pF
				Max			pF
	Turn-on Time	t _{on}	I _F =10 mA	Min	0.5	0.5	ms
	(NO)		l _l =37.5 mA	Тур	3.1	3.1	ms
			√ _L =150 V*	Max	4.5	4.5	ms
	Turn-on Time	t _{on}	I _F =6 mA	Min	0.5	0.5	ms
Ţ	(NC)	On	$I_{1} = 100 \text{ mA}$	Тур	2.3	2.3	ms
R A	()		V _L =50 V*	Max	4.5	4.5	ms
N S F	Turn-off Time	t _{off}	I _F =1 mA	Min		_	ms
F	(NO)	-011	I _L =37.5 mA	Тур	1.2	1.2	ms
E R			V _L =STC V*	Max	4.5	4.5	ms
	Turn-off Time	t _{off}	I _F =10 mA	Min	-	-	ms
	(NC)		I _L =37.5 mA	Тур	1.6	1.6	ms
			V _L =150 V*	Max	4.5	4.5	ms
	Transfer OFF Time	ttfr	I _F =10 mA	Min	0	0	ms
	(NC off to NO on)		I _L =37.5 mA	Тур	0.6	0.6	ms
			V _L =150 V*	Max		-	ms

* Single application.

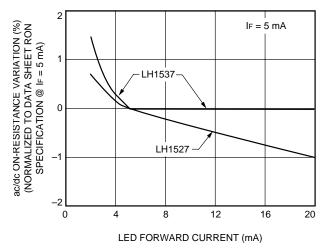
A. LED Voltage vs. Temperature



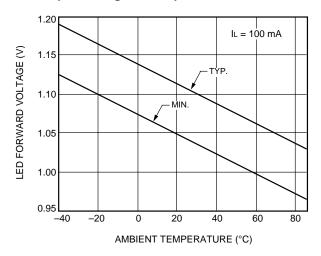
C. LED Current for Switch Turn-Off vs. Temperature



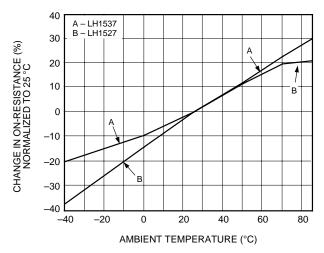
E. Variation in ON-Resistance vs. LED Current



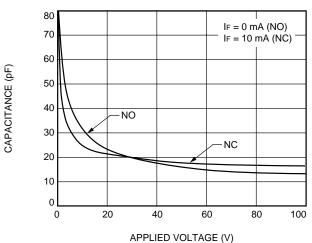
B. LED Dropout Voltage vs. Temperature



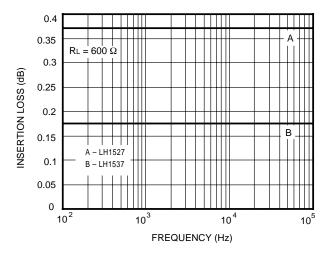
D. ON-Resistance vs. Temperature



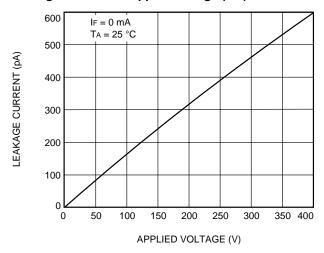
F. Switch Capacitance vs. Applied Voltage



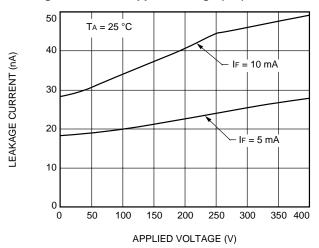
A. Insertion Loss vs. Frequency



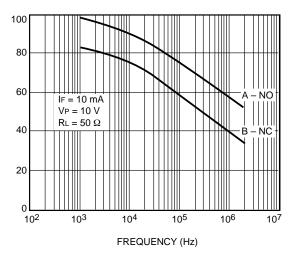
C. Leakage Current vs. Applied Voltage (NO)



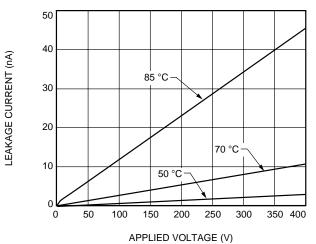
E. Leakage Current vs. Applied Voltage (NC)



B. Output Isolation

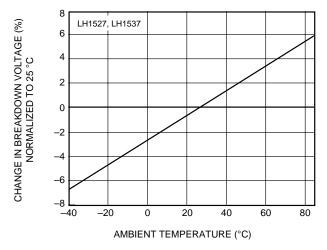


D. Leakage Current vs. Applied Voltage at Elevated Temperatures (NO)

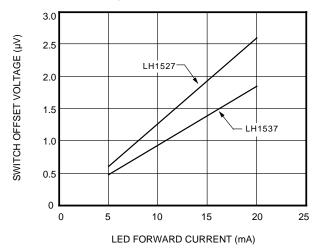


F. Leakage Current vs. Applied Voltage at Elevated Temperatures (NC)

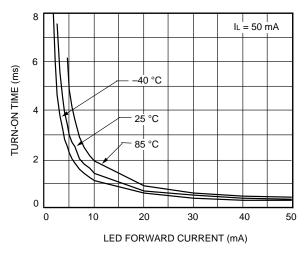
A. Switch Breakdown Voltage vs. Temperature



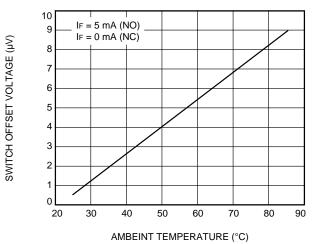
C. Switch Offset Voltage vs. LED Current



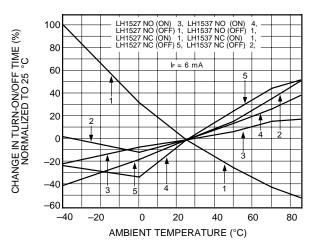
E. NO Turn-On Time vs. LED Current



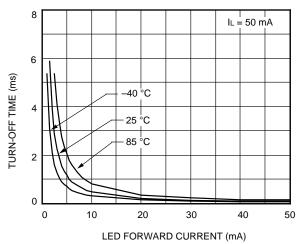
B. Switch Offset Voltage vs. Temperature



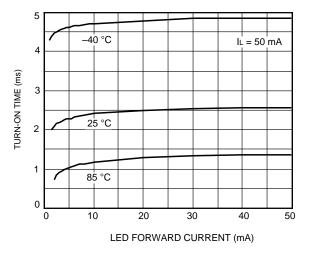
D. t_{on}/t_{off} vs. Temperature



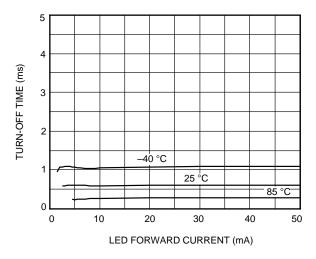
F. NC Turn-Off Time vs. LED Current



A. NC Turn-On Time vs. LED Current



B. NO Turn-Off Time vs. LED Current



• Very low operating current

LH1525ACD 1 Form A, Dual 1 Form A SOP Solid-State Relays

FEATURES

- High-speed operation
- 1500 Vrms I/O isolation
- Current-limit protection
- High surge capability
- Linear, ac/dc operation
- Clean, bounce-free switching
- Extremely low power consumption
- High-reliability monolithic receptor
- Surface-mountable

APPLICATIONS

- PCMCIA Type 2 cards
- Battery powered switch applications
- General telecom switching
- Telephone line interface
 - On/off hook
 - Ring relay
 - Ground start
- Programmable controllers
- Instrumentation

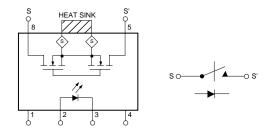
DESCRIPTION

The LH1525 relay is an SPST normally open switche (1 Form A and Dual 1 Form A respectively) in small-outline packages (SOP). They require a minimal amount of LED drive current to operate, making them ideal for battery powered and power consumption sensitive applications.

The relays are constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated BCDMOS technology, is comprised of a photodiode array, switchcontrol circuitry, and MOSFET switches. In addition, the relays employ current-limiting circuitry enabling it to pass FCC 68.302 and other regulatory surge requirements when overvoltage protection is provided.

The LH1525 (1 Form A) is packaged in an 8-pin, plastic SOP (LH1525ACD). Available in sticks or on tape and reel.

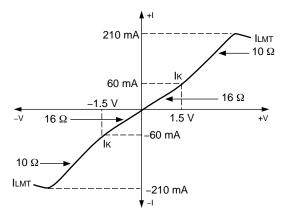
Figure 1. LH1525ACD Functional/Pin Diagram



Functional Description

Figure 3 shows the switch characteristics of the relays. The relay exhibits an ON-resistance that is exceptionally linear through the origin and up to the knee current (lk). Beyond lk, the incremental resistance decreases, minimizing internal power dissipation. Overload currents are clamped at ILMT by the internal current-limit circuitry. The current-limiting circuitry exhibits a negative temperature coefficient, thereby reducing the current-limit value when relay temperature is increased. An extended clamp condition, which increases relay temperature, decreases the current-limit value, resulting in a current foldback characteristic. When the overload is removed, the relay resumes its normal ONresistance characteristic.

Figure 3. Typical ac/dc ON Characteristics



In a 1 Form A relay, to turn the relay on, forward current is applied to the LED. The amount of current applied determines the amount of light produced for the photodiode array. This photodiode array develops a drivevoltage for the MOSFET switch outputs. For hightemperature or high-load current operations, more LED current is required.

Thermal Considerations

To minimize thermal resistance, pins 6 and 7 of the LH1525ACD are formed into a tab. This tab should be soldered to a printed circuit board land pattern of equal or greater size. **Do Not** run metal underneath the device or the input-to-output isolation could be jeopardized.

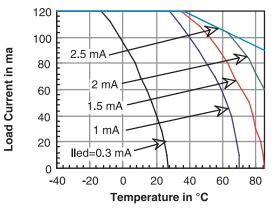
Absolute Maximum Ratings At 25°C

Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to Absolute Maximum Ratings for extended periods can adversely affect the device reliability.

Parameter	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C
Pin Soldering Temperature (t=5 s max.)	T _S	260	°C
Input/Output Isolation Voltage	V _{ISO}	1500	Vrms
LED Input Ratings: Continuous Forward Current Reverse Voltage	l _F V _R	50 5	mA V
Output Operation: dc or Peak ac Load Voltage (I _L ≤ 50 μA) Continuous dc Load Current: One pole operating	V _L	400	V
Power Dissipation: LH1525	P _{DISS}	550	mW
Thermal Resistance, Junction to Ambient	Røja	120	C/W

Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C)$	I _{FON}	1.5		20	mA



Recommended Operating Conditions

Electrical Characteristics $T_A=25^{\circ}C$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	I _{FON}	I _L =100 mA, t=10 ms		0.2	0.5	mA
LED Forward Current for Switch Turn-off	I _{FOFF}	V _L = ±350 V, t=100 ms	0.01	0.1	—	mA
LED Forward Voltage	V _F	I _F = 1.5 mA	0.80	1.15	1.40	V
ON-resistance: Pin 4 (±) to 6 (±)	R _{ON}	I _F =1.5 mA, I _L =±50 mA	17	25	33	Ω
Current Limit	I _{LMT}	I _F =1.5 mA, t=5 ms, V _L =7 V	170	210	270	mA
Output Off-state Leakage Current	_	I _F =0 mA, V _L =±100 V V _L =±400 V		0.04	200 1.0	nA μA
Turn-on Time	t _{on}	I_{F} =1.5 mA, I_{L} =50 mA I_{F} =5.0 mA, I_{L} =50 mA		1.0 0.3	 1.0	ms ms
Turn-off Time	t _{off}	I_{F} =1.5 mA, I_{L} =50 mA I_{F} =5.0 mA, I_{L} =50 mA		0.2 0.25	 0.5	ms ms

LH1533 Dual 1 Form A High-Voltage Solid State Relays

FEATURES

- Load voltage, 350 V
- Load current 70 mA
- TR_{ON}, typical at 100 mA
- 3750 Vrms I/O isolation
- Current-limit protection
- High-surge capability
- Linear, ac/dc or dc operation
- Clean, bounce-free switching
- Low power consumption
- High-reliability monolithic receptor
- Surface-mountable

APPLICATIONS

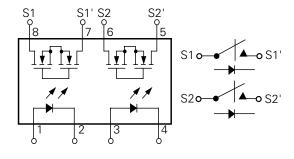
- General telecom switching
 - On/off-hook
 - Dial pulse
 - Ground start
 - Ground fault protection
- Instrumentation
- Industrial controls
- Peripherals

DESCRIPTION

The LH1533 (Dual 1 Form A) relays are SPST normally open switches that can replace electromechanical relays in many applications. The relays are constructed using a GaAIAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated BICMOS technology, is comprised of a photodiode array, switch control circuitry, and MOSFET switches. In addition, the relay employs current-limiting circuitry enabling it to pass FCC 68.302 and other regulatory voltage surge requirements when overvoltage protection is provided.

The LH1533 (Dual 1 Form A) relay is packaged in an 8-pin DIP (LH1533AB) or in a surface-mount, option 9 (LH1533AAC). The surface-mount devices are available in sticks or on tape and reel.

Figure 1. Functional Diagram



Absolute Maximum Ratings $T_A{=}25^\circ\mathrm{C}$

Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other condition in excess of those given in the operational sections of the data sheet. Exposure to Absolute Maximum Ratings for extended periods can adversely affect the device reliability.

Parameter	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-40 to +150	C°
Pin Soldering Temperature (t=10 s max.)	Τ _S	260	С
Input/Output Isolation Test Voltage (t=1 sec)	V _{ISO}	5300	Vrms
LED Input Ratings: Continuous Forward Current Reverse Voltage (I _R ≤10 µA)	I _F V _R	50 5	mA V
Output Ratings: dc or Peak ac Load Voltage (I _L ≤50 μA) Continuous dc Load Current LH1533 (One Pole Operating)	V _L	350 90	V mA
LH1533 (Two Poles Operating)	Ι	70	mA
Power Dissipation LH1533	P _{DISS}	600	mW

Electrical Characteristics T_A=25°C

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	I _{Fon}	I _L =100 mA, t=10 ms	_	_	2.5	mA
LED Forward Current for Switch Turn-off	I _{Foff}	V _L =±300 V	0.01	-	_	mA
LED Forward Voltage	V _F	I _F =5 mA	0.9	1.2	1.4	V
ON-resistance	R _{ON}	I _F =5 mA, I _L =±90 mA	25	37	50	Ω
Current Limit	I _{LMT}	I _F =5 mA, t=5 ms, V _L =13 V	150	200	270	mA
Output Off-state Leakage Current	_	I _F =0 mA, V _L =±350 V	_	-	1.0	μΑ
Turn-on Time	t _{on}	I _F =5 mA, I _L =50 mA	_	_	3.0	ms
Turn-off Time	t _{off}	I _F =5 mA, I _L =50 mA	_	_	3.0	ms

LH1525 LH1526 1 Form A, Dual 1 Form A High-Voltage Solid State Relays

FEATURES

	LH1525	LH1526	Units
Load Voltage	400	400	V
Load Current ac/dc dc	120 250	120 250	mA mA
Typical R _{ON}	25	25	Ω
Typical Operating Current	500	500	μΑ
t _{on} /t _{off} (max)	0.8/0.4	0.8/0.4	ms
Current Limit: ac/dc	Yes	Yes	_

- Extremely low operating current
- High-speed operation
- 3750 Vrms I/O isolation
- Current-limit protection
- High surge capability
- Linear, ac/dc operation
- dc-only option
- Clean, bounce-free switching
- Low power consumption
- High-reliability monolithic receptor
- Surface-mountable

APPLICATIONS

- General telecom switching:
- Telephone line interface
- On/off hook
- Ring relay
- Break switch
- Ground start
- Battery-powered switch applications
- Industrial controls:
 - Microprocessor control of solenoids, lights, motors, heaters, etc.
- Programmable controllers
- Instrumentation

DESCRIPTION

The LH1525 and LH1526 relays as SPST normally open switches (1 Form A) that can replace electromechanical relays in many applications. The relays require a minimal amount of LED drive current to operate, making it ideal for battery-powered and power consumption sensitive applications. The relay is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated BCDMOS technology, comprised of a photodiode array, switch-control circuitry, and MOSFET switches. In addition, the relay employs current-limiting circuitry, enabling it to pass FCC 68.302 and other regulatory surge requirements when overvoltage protection is provided. The relay can be configured for ac/dc or dc-only operation.

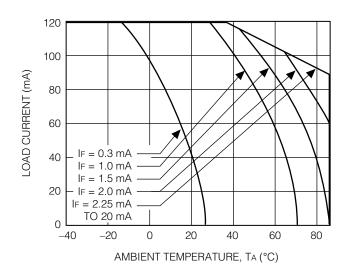
The LH1525 is packaged in a 6-pin, plastic DIP (LH1525AT) or in a surface-mount gull wing (LH1525AAB). The LH1526 is packaged in a 8-pin, plastic DIP (LH1526AB) or in a surface-mount gull wing (LH1526AAC). Both devices are available in sticks or on tape and reel.

Absolute Maximum Ratings $T_A{=}25^\circ C$

Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to Absolute Maximum Ratings for extended periods can adversely affect device reliability.

Parameter	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C
Pin Soldering Temperature (t=10 s max.)	T _S	260	C°
Input/Output Isolation Test Voltage (t=1 sec)	V _{ISO}	5300	Vrms
LED Input Ratings: Continuous Forward Current Reverse Voltage	I _F V _R	50 8	mA V
Output Operation LH1525, LH1526 (ea. ch.): dc or Peak ac Load Voltage (I _L =≤50 μA) Continuous dc Load Current:	VL	400	V
Bidirectional Operation, Pin 4 to 6 (LH1525) Unidirectional Operation, Pins 4, 6 (+) to Pin 5 (–)		125 250	mA mA
Two Role Operation (LH1526 only)	ΙL	100	mA
Power Dissipation: LH1525 LH1526	P _{DISS} P _{DISS}	550 600	mW mW

Recommended Operating Conditions

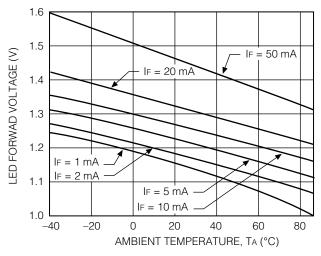


Electrical Characteristics $T_A=25^{\circ}C$ Mimimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

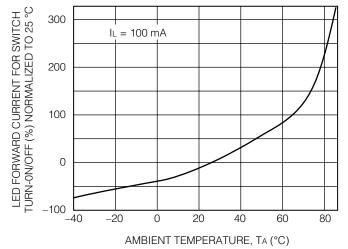
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Input		1		1		1
LED Forward Current for Switch Turn-on	I _{Fon}	I _L =100 mA, t=10 ms	_	0.3	0.5	mA
LED Forward Current for Switch Turn-off	I _{Foff}	V _L = ±350 V, t=100 ms	0.001	0.1		mA
LED Forward Voltage	V _F	I _F =1.5 mA	0.80	1.15	1.40	V
Output	•					
ON-resistance: ac/dc, each pole dc Pins 4, 6 (+) to 5 (-) (LH1525 only)	R _{ON}	I _F =1.5 mA, I _L =±50 mA I _F =1.5 mA, I _L =100 mA	17 4.25	25 6.25	33 8.25	Ω Ω
OFF-resistance	R _{OFF}	I _F =0 mA, V _L =±100 V	—	5000		GΩ
Current Limit	I _{LMT}	I _F =1.5 mA, t=5 ms, V _L =7 V	170	210	270	mA
Output Off-state Leakage Current	_	I _F =0 mA, V _L =±100 V I _F =0 mA, V _L =±400 V		0.04	200 1.0	nA μA
Output Capacitance	_	I _F =0 mA, V _L =1 V I _F =0 mA, V _L =50 V	—	37 13		pF pF
Switch Offset		I _F =5 mA	—	0.25		μV
Transfer	•					
Input/Output Capacitance	C _{ISO}	V _{ISO} =1 V	_	0.8		pF
Turn-on Time	t _{on}	I_F =1.5 mA, I_L =50 mA I_F =5.0 mA, I_L =50 mA		1.00 0.25	 0.8	ms ms
Turn-off Time	t _{off}	I_F =1.5 mA, I_L =50 mA I_F =5.0 mA, I_L =50 mA		0.20 0.25	0.4	ms ms

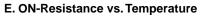
Typical Performance Characteristics

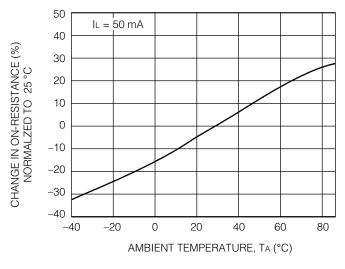
A. LED Voltage vs. Temperature



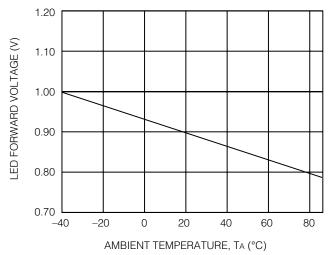




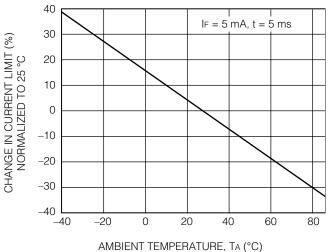




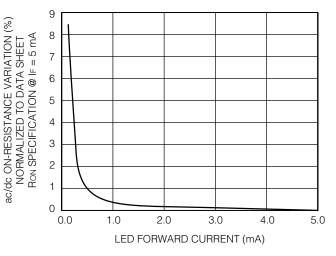
B. LED Dropout Voltage vs. Temperature





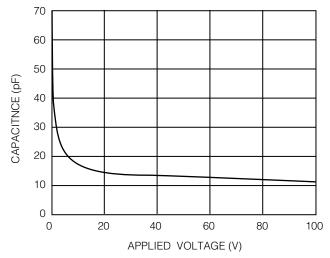


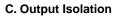
F. Variation in ON-Resistance vs. LED Current

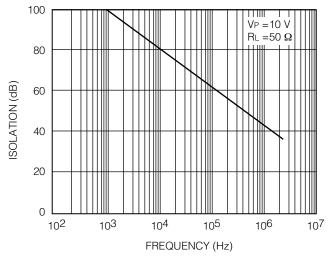


Typical Performance Characteristics (continued)

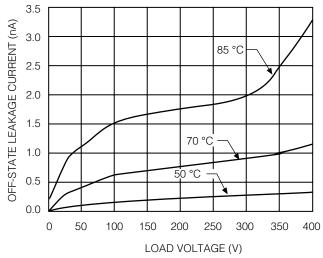
A. Switch Capacitance vs. Applied Voltage



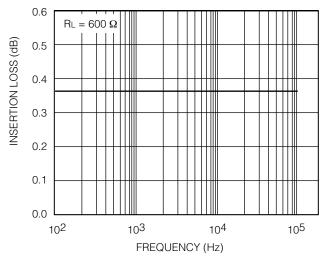




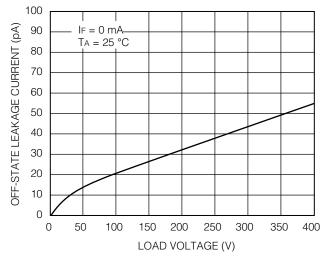


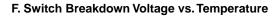


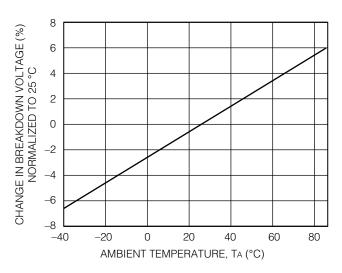
B. Insertion Loss vs. Frequency



D. Leakage Current vs. Applied Voltage

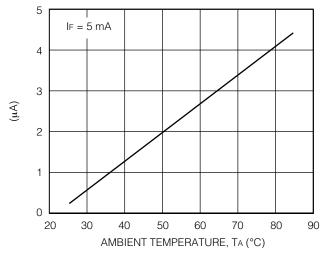




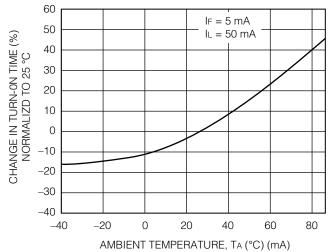


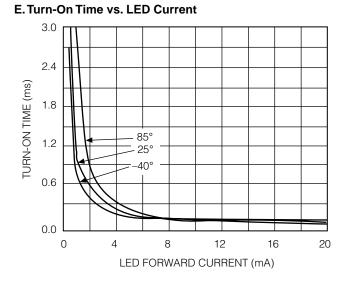
Typical Performance Characteristics (continued)

A. Switch Offset Voltage vs. Temperature

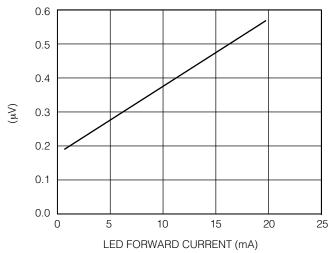


C. Turn-On Time vs. Temperature

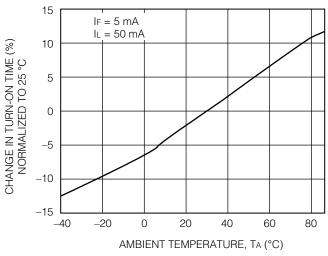




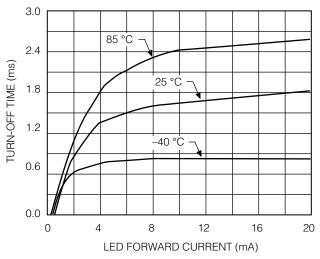
B. LED Offset Voltage vs. LED Current



D. Turn-Off Time vs. Temperature



F. Turn-off Time vs. LED Current



APPLICATIONS

Input Control

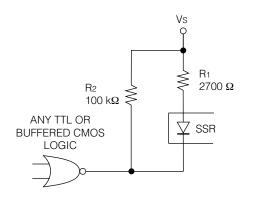
The LH1525 low turn-on current SSR has highly sensitive photo-detection circuits that will detect even the most minute currents flowing through the LED. Leakage current must be considered when designing a circuit to turn on and off these relays.

Figure 23 shows a typical logic circuit for providing LED drive current. R1 is the input resistor that limits the amount of current flowing through the LED. For 5 V operation, a 2700 Ω resistor will limit the drive current to about 1.4 mA. Where high-speed actuation is desireable, use a lower value resistor for R1. An additional RC peaking circuit is not required with the LH1525 relay.

R2 is an optional pull-up resistor which pulls the logic level high ouput (V_{OH}) up toward the V_S potential. The pull-up resistance is set at a high value to minimize the overall current drawn from the V_S. The primary purpose of this resistor is to keep the differential voltage across the LED below its turn-on threshold. LED dropout voltage is graphed vs. temperature in the Typical Performance Characteristics section. When the logic gate is high, leakage current will flow through R₂. R₂ will draw up to 8 μ A before developing a voltage potential which might possibly turn on the LED.

Many applications will operate satisfactorily without a pull-up resistor. In the logic circuit in Figure 1 the only path for current to flow is back into the logic gate. Logic leakage is usually negligible. Each application should be evaluated, however, over the full operating temperature range to make sure that leakage current through the input control LED is kept to a value less than the minimum LED forward current for switch turn-off specification.

Figure 1. Input Control Circuit



LH1547 1 Form A dc High-Voltage Solid State Relay

FEATURES

	LH1547	Units
Load Voltage	400	V
Load Current	120	mA
Typical R _{ON}	23	Ω

- 3750 Vrms I/O isolation
- Current-limit protection
- Linear dc operation
- High-surge capability
- Clean, bounce-free switching
- Low power consumption
- High-reliability monolithic receptor
- Surface-mountable

APPLICATIONS

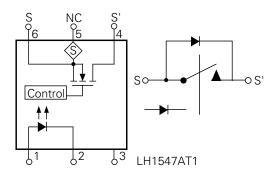
- General telecom switching
- Programmable controllers
- Industrial controls
- Instrumentation
- Peripherals

DESCRIPTION

The LH1547 is a SPST normally open unidirectional relay that can switch ac and dc signals. The relay is constructed using a GaAIAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated BICMOS technology, is comprised of a photodiode array, switch control circuitry, and a DMOS switch.

The LH1547 relay is packaged in a 6-pin DIP (LH1547AT1) or in a surface-mount gull wing (LH1547AAB1).

Figure 1. Functional Diagram (LH1547)



Absolute Maximum Ratings T_A=25°C

Stresses in excess of the Absolute Maximum Ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of the data sheet. Exposure to Absolute Maximum Ratings for extended periods can adversely affect the device reliability.

Parameter	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C
Pin Soldering Temperature (t=10 s max.)	T _S	260	°C
Input/Output Isolation Test Voltage (t=1 sec)	V _{ISO}	5300	Vrms
LED Input Ratings: Continuous Forward Current Reverse Voltage (I _R ≤10 μA)	I _F V _R	50 10	mA V
Output Operation: dc or Peak ac Load Voltage (I _L ≤50 μA) Continuous dc Load Current	VL IL	400 120	V mA
Power Dissipation	P _{DISS}	500	mW

Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on (T _A =–40°C to +85°C)	IFON	5		20	mA

Electrical Characteristics $T_{A}{=}25^{\circ}C$

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	I _{Fon}	I _L =90 mA, t=10 ms		0.9	2	mA
LED Forward Current for Switch Turn-off	I _{Foff}	V _L =±350 V	0.1	0.4		mA
LED Forward Voltage	V _F	I _F =10 mA	1.15	1.22	1.45	V
ON-resistance	R _{ON}	I _F =5 mA	12	23	34	Ω
OFF-resistance	R _{OFF}	I _F =0 mA, V _L =±100 V	_	3300		GΩ
Current Limit	I _{LMT}	$I_F=5$ mA, t=5 ms $V_L=10$ V	150	210	270	mA
Output Off-state Leakage Current	_	I _F =0 mA, V _L =±100 V V _L =±400 V		0.03	200 1.0	nA μA
Turn-on Time	t _{on}	I_{F} =5 mA, V _L =50 V R _L =1 k Ω		1.6	5.0	ms
Turn-off Time	t _{off}	I_{F} =5 mA, V _L =50 V R _L =1 k Ω		2.2	5.0	ms

LH1191 High-Voltage Solid State Relay

FEATURES

- 1500 Vrms input/output isolation
- High-surge capability
- Low ON-resistance
- Clean, bounce-free switching
- dv/dt typically better than 500 V/μs
- Low power consumption
- Monolithic IC reliability

APPLICATIONS

- Telecom switching
- Transducer driver
- High-voltage testers
- Industrial controls
- Triac predriver
- Isolation switching

DESCRIPTION

The LH1191 High-Voltage, Solid State Relay is a single pole, normally open switch (1 Form A) that can replace electromechanical relays in many applications. The relay features logic-level input control of isolated high-voltage switch outputs. The output is rated at 280 V and can handle loads up to 120 mA. The relay can switch both ac and dc loads and is ideal for audio frequency or dc applications. Typical ON-resistance at 25 mA is 25 Ω .

The LH1191 relay consists of a GaAIAs LED that optically couples control signals to a monolithic integrated circuit. Optical coupling provides 1500 Vrms of input/output isolation. The integrated circuit is a dielectrically isolated, high-voltage die comprised of photodiode arrays, switch control circuitry, and high-voltage DMOS transistor switches.

In operation, the device is exceptionally linear up to 55 mA. Beyond 55 mA, the incremental resistance decreases, thereby minimizing internal power dissipation. Overload currents are clamped at 210 mA by internal current limiting. An extended clamp condition, which increases relay temperature, results in a reduction in clamp current, thereby further reducing internal power dissipation and preserving the relay's integrity. The relay is packaged in a 6-pin, plastic DIP (LH1191AT1) or in a 6-pin, surface-mount, gull-wing configuration (LH1191AAB1).

Absolute Maximum Ratings T_A=25°C

Stresses exceeding the values listed under Absolute Maximum Ratings can cause permanent damage to the device. This is an absolute stress rating only. Functional operation of the device at these or any other conditions in excess of those indicated in the operational sections of this data sheet is not implied. Exposure to maximumrating conditions for extended periods ot time can adversely affect the device reliability.

Rating	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-40 to +100	°C
Pin Soldering Temperature (t=7 s max.)	T _S	270	°C
Input/Output Isolation Voltage (t=60 s min.)	V _{ISO}	1500	Vrms
LED Input Ratings: Continuous forward current Reverse voltage	I _F V _R	20 10	mA V
Output Operation: dc or peak ac load voltage (I _L ≤ 50 μA) Continuous dc load current	V _L	280 135	V mA
Power Dissipation	P _{DISS}	500	mW

Recommended Operating Conditions $T_A=25^{\circ}C$

(unless otherwise specified)

Parameter	Symbol	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on $(T_A=-40^{\circ}C \text{ to } +85^{\circ}C)$	I _{FON}	6	10	20	mA
Continuous dc Load Current	١	_	55	120	mA
ac rms Load Current			35	85	mA

Electrical Characteristics T_A=25°C

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	I _{Fon}	I_{L} (min)=120 mA, V _L =±7 V, t=10 ms	_	1.3	2.5	mA
LED Forward Current for Switch Turn-off	I _{Foff}	I _F =0.2 mA, V _L =±250 V	0.2	1.2	—	mA
LED Forward Voltage	V _F	I _F =10 mA	1.15	1.22	1.45	V
ON-resistance	R _{ON}	I _F =5 mA, I _L = ±25 mA	11	25	33	Ω
Current Limit	I _{LMT}	$I_{F}=5 \text{ mA}, V_{L}=\pm7 \text{ V}, t=10 \text{ ms}$	140	210	260	mA
Ouput Off-state Leakage Current	—	I _F =0, V _L =±100 V	—	0.03	200	nA
Turn-on Time	t _{on}	$I_F=5$ mA, $V_L=+150$ V, $R_L=4$ k Ω	—	1.4	2.0	ms
Turn-off Time	t _{off}	$I_F=5$ mA, $V_L=+150$ V, $R_L=4$ k Ω	_	0.9	2.0	ms
Feedthrough Capacitance Pin 4 to 6	_	I _F =0, V _L =4 Vp-p, 1 kHz	-	24		pF

LH1085 High-Voltage Solid State Relay

FEATURES

- 1500 Vrms input/output isolation
- Low ON-resistance
- Clean, bounce-free switching
- dv/dt typically better than 500 V/μs
- Low power consumption
- Monolithic IC reliability

APPLICATIONS

- High-voltage testers
- Industrial controls
- Telecom switching
- Triac predriver
- Isolation switching

DESCRIPTION

The LH1085 High-Voltage, Solid State Relay is a single pole, normally open switch (1 Form A) that can replace electromechanical relays in many applications. The relay features logic-level input control of isolated high-voltage switch outputs. The output is rated at 350 V and can handle loads up to 135 mA. The relay can switch both ac and dc loads and is ideal for audio frequency or dc applications. Typical ON-resistance at 25 mA is 30 Ω .

The LH1085 relay consists of a GaAIAs LED that optically couples control signals to a monolithic integrated circuit. Optical coupling provides 1500 Vrms of input/output isolation. The integrated circuit is a dielectrically isolated, high-voltage die comprised of photodiode arrays, switch control circuitry, and high-voltage DMOS transistor switches.

In operation, the device is exceptionally linear up to 45 mA. Beyond 45 mA, the incremental resistance decreases, thereby minimizing internal power dissipation. Overload currents are clamped at 300 mA by internal current limiting. An extended clamp condition, which increases relay temperature, results in a reduction in clamp current, thereby further reducing internal power dissipation and preserving the relay's integrity. The relay is packaged in a 6-pin, plastic DIP (LH1085AT1) or in a 6-pin, surface-mount, gull-wing configuration (LH1085AAB1).

Absolute Maximum Ratings T_A=25°C

Stresses exceeding the values listed under Absolute Maximum Ratings can cause permanent damage to the device. This is an absolute stress rating only. Functional operation of the device at these or any other conditions in excess of those indicated in the operational sections of this data sheet is not implied. Exposure to maximumrating conditions for extended periods ot time can adversely affect the device reliability.

Rating	Symbol	Value	Unit
Ambient Operating Temperature Range	T _A	-40 to +85	°C
Storage Temperature Range	T _{stg}	-40 to +100	°C
Pin Soldering Temperature (t=7 s max.)	T _S	270	°C
Input/Output Isolation Voltage (t=60 s min.)	V _{ISO}	1500	Vrms
LED Input Ratings: Continuous forward current Reverse voltage	I _F V _R	20 10	mA V
Output Operation: dc or peak ac load voltage (I _L ≤ 50 µA) Continuous dc load current Peak load current (t=10 ms)	V _L I _L I _P	350 135 400	V mA mA
Power Dissipation	P _{DISS}	500	mW

Recommended Operating Conditions $T_A=25$ °C (unless otherwise specified)

Parameter	Symbol	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on (T _A =-40°C to +85°C)	I _{FON}	8	10	20	mA
Continuous dc Load Current	١ _L	_	45	135	mA
ac rms Load Current			30	135	mA

Electrical Characteristics T_A=25°C

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
LED Forward Current for Switch Turn-on	I _{Fon}	I_{L} (min)=150 mA, V _L =±9 V, t=10 ms	_	1.3	2.5	mA
LED Forward Current for Switch Turn-off	I _{Foff}	I _F =0.2 mA, V _L =±300 V	0.2	1.2	_	mA
LED Forward Voltage	V _F	I _F =10 mA	1.15	1.22	1.45	V
ON-resistance	R _{ON}	$I_F=5 \text{ mA}, I_L= \pm 25 \text{ mA}$	20	30	37	Ω
Current Limit	I _{LMT}	$I_{F}=5 \text{ mA}, V_{L}=\pm9, t=10 \text{ ms}$	225	300	400	mA
Ouput Off-state Leakage Current	_	I _F =0, V _L =±100 V	—	0.03	200	nA
Turn-on Time	t _{on}	I_{F} =5 mA, V_{L} =+150 V, R_{L} =4 k Ω	—	1.4	2.0	ms
Turn-off Time	t _{off}	I_{F} =5 mA, V_{L} =+150 V, R_{L} =4 k Ω	—	0.9	2.0	ms
Feedthrough Capacitance Pin 4 to 6	_	I _F =0, V _L =4 Vp-p, 1 kHz	—	24		pF